1376135-2 - ACTIVE

Dynamic Series | Dynamic 2000 Series

TE Internal #: 1376135-2 PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 2.5 mm [. 099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 5A, gold plated



Connector System: Wire-to-Board

Number of Positions: 3

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.099 in]

PCB Mount Orientation: Horizontal

All Header Assembly: Wire-to-Board, 5A, gold plated (44)

Features

Product Type Features

Connector System

Wire-to-Board

Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	3	
Number of Rows	1	
PCB Mount Orientation	Horizontal	
Body Features		
Primary Product Color	Black	
Contact Features		
Contact Mating Area Plating Material Thickness	.38 μm[15 μin]	
Contact Mating Area Plating Material	Gold	
Contact Type	Pin	
Contact Current Rating (Max)	5 A	

C For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



Termination Features

Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mating Alignment Type	Polarization	
Mating Retention	With	
PCB Mount Retention Type	Retention Leg	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	Without	
PCB Mount Retention	With	
Housing Features		
Housing Material	Polyester GF	
Centerline (Pitch)	2.5 mm[.099 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	

Industry Standards

UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Type	Box, Tube	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900	

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

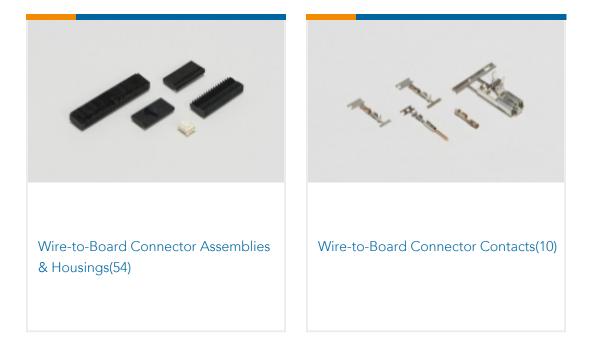
Compatible Parts



TE Part # 2-1318120-3 DYNAMIC D2100 REC HSG 3P SGL Y

Also in the Series | Dynamic 2000 Series

Insertion & Extraction Tools(1)	PCB Connector Mounting(4)	PCB Headers & Receptacles(44)	PCB Terminal Blocks(23)

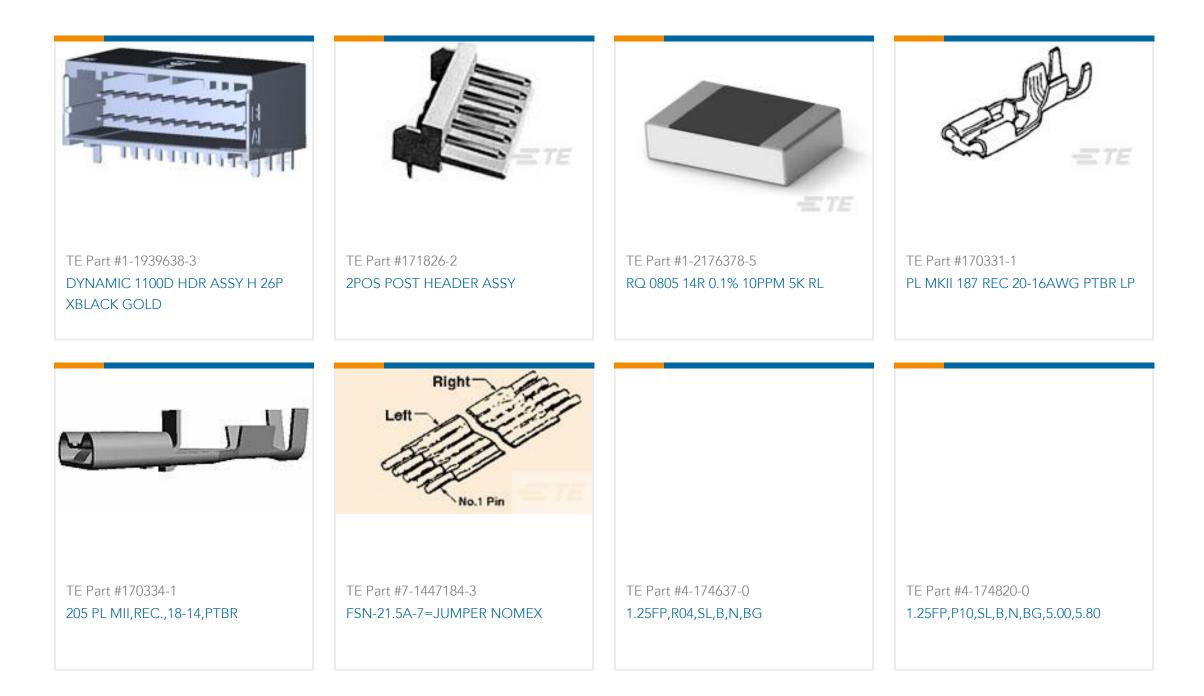


Customers Also Bought

C For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series





Documents

Product Drawings DYNAMIC D2100 HDR H ASSY 3P Y

Japanese

CAD Files

Customer View Model ENG_CVM_CVM_1376135-2_G.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1376135-2_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1376135-2_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages 1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Dynamic Connector D-2000 Series

Japanese

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



Application Specification

Japanese

Product Environmental Compliance MD_1376135-2_04152012230

English

Agency Approvals

Agency Approval Document

English